



PLA110 Single Pole, Normally Open OptoMOS® Relay

Parameters	Ratings	Units
Blocking Voltage	400	V _P
Load Current	150	mA
Max On-resistance	22	Ω

Features

- 3750V_{rms} Input to Output Isolation
- Small 6-Pin Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- · No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- FCC Compatible
- VDE Compatible
- · Machine Insertable, Wave Solderable

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, PocketSize)
 - Hook Switch
 - Dial Pulsing
 - Ground Start
 - Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - · Meters (Watt-Hour, Water, Gas)
- Medical Equipment Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

PLA110 is a normally open (1-Form-A) solid state relay that uses optically coupled MOSFET technology to provide 3750V_{rms} of input to output isolation. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS architecture. The optically coupled output is controlled by a highly efficient GaAlAs infrared LED.

The PLA110 can be used to replace mechanical relays, and offers the superior reliability associated with semiconductor devices. Because it has no moving parts, it offers faster, bounce-free switching in a more compact surface mount or thru-hole package.

Approvals

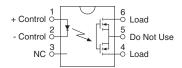
- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 09 07 49410 004

Ordering Information

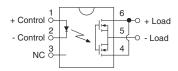
Part #	Description	
PLA110	6-Lead DIP (50/Tube)	
PLA110S	6-Lead Surface Mount (50/Tube)	
PLA110STR	6-Lead Surface Mount (1000/Reel)	

Pin Configuration

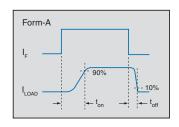
AC/DC Configuration



DC Only Configuration



Switching Characteristics of Normally Open Devices











Absolute Maximum Ratings @ 25°C

Parameter	Min	Max	Units
Blocking Voltage	-	400	V_P
Reverse Input Voltage	-	5	V
Input Control Current	-	50	mA
Peak (10ms)	-	1	Α
Input Power Dissipation ¹	-	150	mW
Total Package Dissipation ²	-	800	mW
Isolation Voltage, Input to Output	3750	-	V_{rms}
Operational Temperature	-40	+85	°C
Storage Temperature	-40	+125	°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

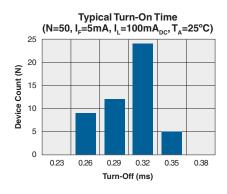
Parameters	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics	`					
Load Current						
Continuous, AC/DC Configuration	-		-	-	150	mA.
Continuous, DC Configuration	-	ן י _∟	-	-	250	IIIA
Peak	t=10ms	I _{LPK}	-	-	400	
On-Resistance						
AC/DC Configuration	I _L =150mA	D D	-	-	22	Ω
DC Configuration	I _L =250mA	- R _{ON}	-	-	7	52
Off-State Leakage Current	V _L =400V _P	I _{LEAK}	-	-	1	μΑ
Switching Speeds						
Turn-On	t _{on}	t _{on}	-	-	1	
Turn-Off	I _F =5mA, V _L =10V	t _{off}	-	-	0.5	ms
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics						
Input Control Current	I _L =150mA	I _F	-	-	5	mA
Input Dropout Current	-	I _F	0.4	0.7	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μΑ
Common Characteristics	1	'		1	1	1
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

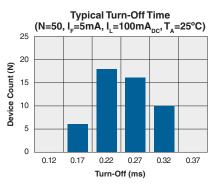
¹ Derate Linearly 1.33 mW / °C

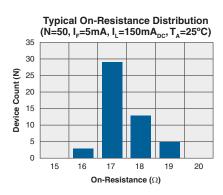
² Derate Linearly 6.67 mW / °C

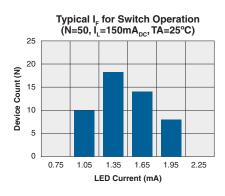


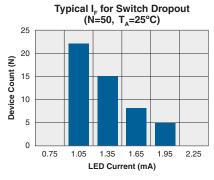
PERFORMANCE DATA*

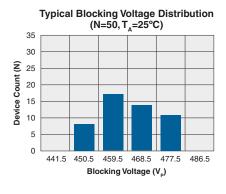


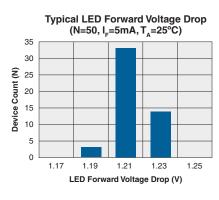


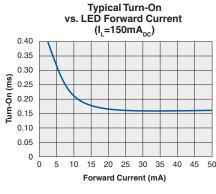


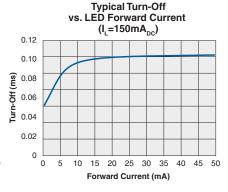


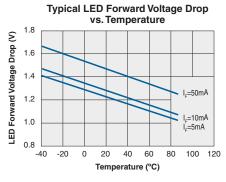


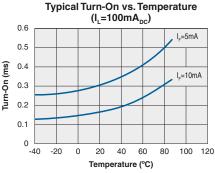


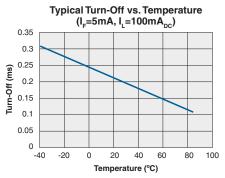








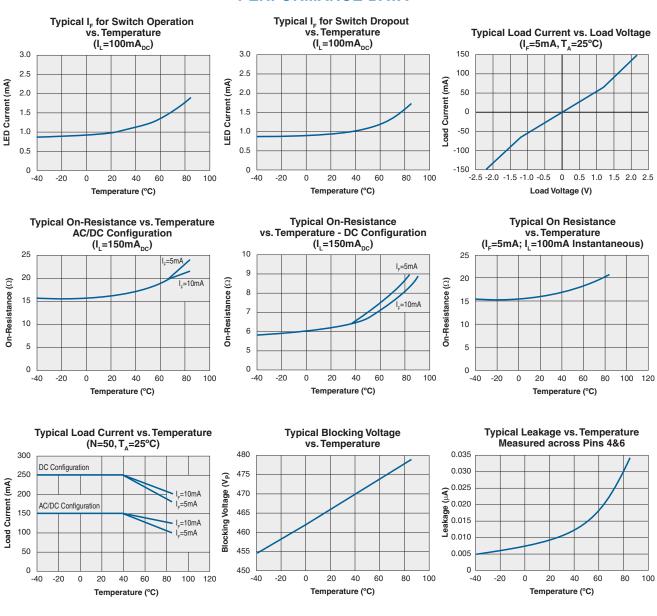


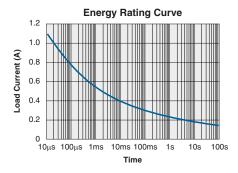


^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



PERFORMANCE DATA*





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Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingression. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to

the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
PLA110 / PLA110S	MSL 1

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
PLA110 / PLA110S	250°C for 30 seconds

Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.







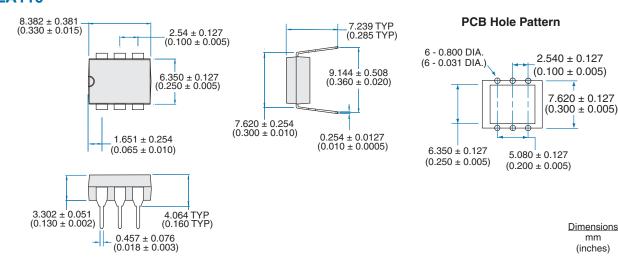
Dimensions

 mm (inches)

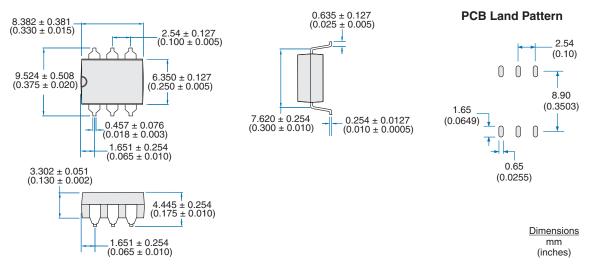


MECHANICAL DIMENSIONS

PLA110

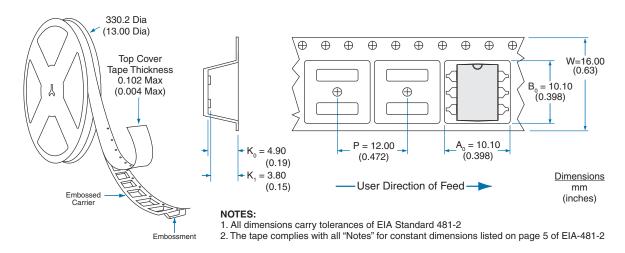


PLA110S





PLA110S Tape & Reel



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